

Description

The VST12N088 uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{\text{DS(ON)}}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

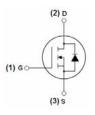
• V_{DS} =120V, I_{D} =50A $R_{DS(ON)}$ =8.8m Ω (typical) @ V_{GS} =10V $R_{DS(ON)}$ =10.7m Ω (typical) @ V_{GS} =4.5V

- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 150 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification





TO-220C

Schematic Diagram

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VST12N088-TC	VST12N088	TO-220C	-	-	-

Absolute Maximum Ratings (T_A=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	120	V	
Gate-Source Voltage	V _G s	±20	V A A A	
Drain Current-Continuous	I _D	50		
Drain Current-Continuous(T _C =100°C)	I _D (100℃)	35.3		
Pulsed Drain Current	I _{DM}	200		
Maximum Power Dissipation	P _D	105	W	
Derating factor		0.7	W/℃	
Single pulse avalanche energy (Note 5)	E _{AS}	210	mJ	
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 175	$^{\circ}$	

Thermal Characteristic

Thermal Resistance,Junction-to-Case ^(Note 2)	R _{θJC}	1.42	°C/W
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Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	120	-	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =120V,V _{GS} =0V	-	-	1	μA	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA	
On Characteristics (Note 3)							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.0	1.7	2.2	V	
Drain Source On State Begintenes	В	V _{GS} =10V, I _D =20A	-	8.8	10.1	mΩ	
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =20A	-	10.7	13.9	mΩ	
Forward Transconductance	g FS	V _{DS} =5V,I _D =20A	-	30	-	S	
Dynamic Characteristics (Note4)							
Input Capacitance	C _{lss}		-	3050	-	PF	
Output Capacitance	Coss	V_{DS} =60V, V_{GS} =0V, F=1.0MHz	-	274	-	PF	
Reverse Transfer Capacitance	C _{rss}	r-1.0lvinz	-	17.8	-	PF	
Switching Characteristics (Note 4)							
Turn-on Delay Time	t _{d(on)}		-	11	-	nS	
Turn-on Rise Time	t _r	V_{DD} =60 V , I_{D} =20 A	-	7	-	nS	
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{G} =1.6 Ω	-	30	-	nS	
Turn-Off Fall Time	t _f		-	4	-	nS	
Total Gate Charge	Qg		-	45	-	nC	
Gate-Source Charge	Q _{gs}	$V_{DS}=60V, I_{D}=20A,$	-	11.6	-	nC	
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	6	-	nC	
Drain-Source Diode Characteristics			•				
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =20A	-	-	1.2	V	
Diode Forward Current (Note 2)	Is		-	-	20	Α	
Reverse Recovery Time	t _{rr}	$T_J = 25$ °C, $I_F = I_S$	-	78	-	nS	
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	149	-	nC	

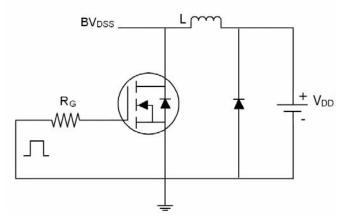
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\text{C}$,V_DD=50V,V_G=10V,L=0.5mH,Rg=25 Ω

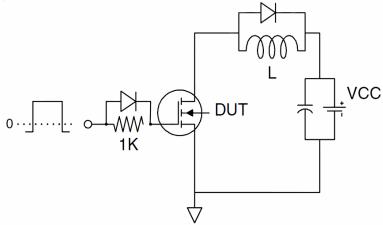


Test Circuit

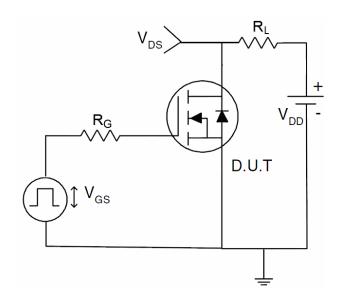
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics

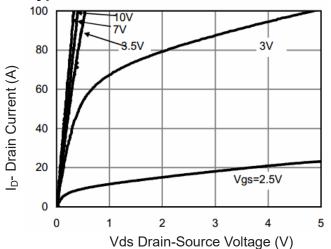


Figure 1 Output Characteristics

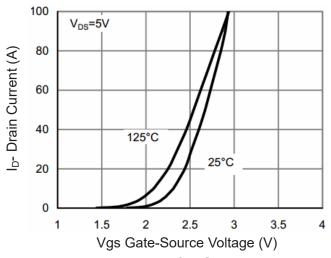


Figure 2 Transfer Characteristics

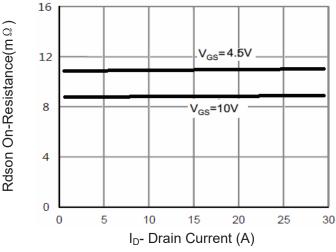


Figure 3 Rdson-Drain Current

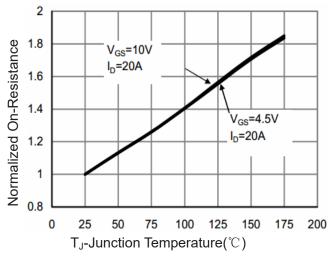


Figure 4 Rdson-Junction Temperature

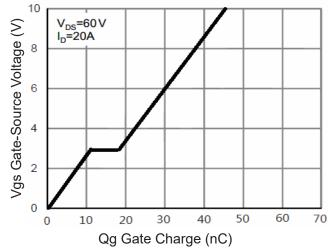


Figure 5 Gate Charge

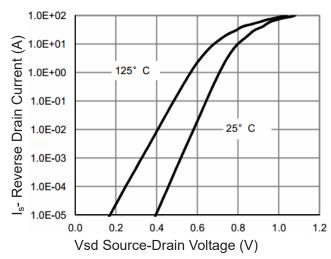


Figure 6 Source- Drain Diode Forward



Ip- Drain Current (A)

0.0

0.01

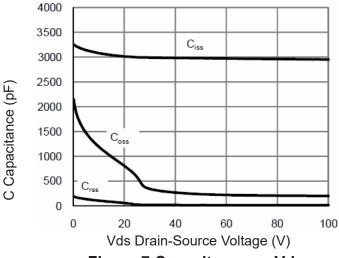


Figure 7 Capacitance vs Vds

1000.0

100.0

100.0

R_{DS(ON)} 100μs

100μs

100μs

100ms

10ms

10ms

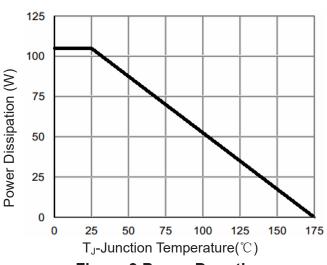
Vds Drain-Source Voltage (V)
Figure 8 Safe Operation Area

100

1000

10

0.1



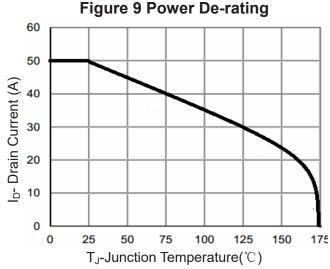


Figure 10 Current De-rating

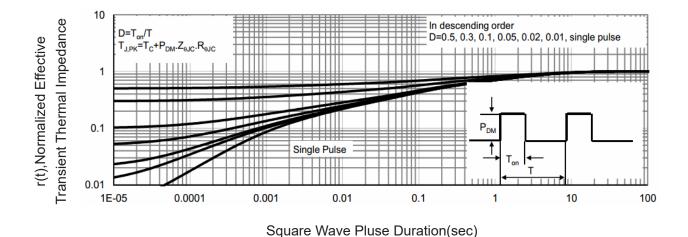


Figure 11 Normalized Maximum Transient Thermal Impedance